

TEI 2017

<http://www.tei-conf.org/17/>

11th International Conference on
Tangible, Embedded and Embodied Interactions

20-23 March 2017 **Yokohama, Japan**



Sponsorship Plans

TEI 2017 offers four general levels of sponsorship. Each package can be extended to adapt to your needs.

Premium Sponsor: 1000 kJPY / 10,000 USD

- 5 Free Registration (reception and banquet included)
- Demo Booth (larger size)
- Corporate Logo (in Web, Printed Program)
- Give-away for conference attendees (packed into a conference bag)
- Naming conference events (reception, banquet, coffee breaks)
- + more

Gold Sponsor: 500 kJPY / 5,000 USD

- 3 Free Registration (reception and banquet included)
- Demo Booth (larger size)
- Corporate Logo (in Web, Printed Program)
- Give-away for conference attendees (packed into a conference bag)
- Naming conference events (reception, banquet, coffee breaks)

Silver Sponsor: 250 kJPY / 2,500 USD

- 1 Free Registration (reception and banquet included)
- Demo Booth (smaller size)
- Corporate Logo (in Web, Printed Program)
- Give-away for conference attendees (packed into a conference bag)

Bronze Sponsor: 100 kJPY / 1,000 USD

- Corporate Logo (in Web, Printed Program)
- Give-away for conference attendees (packed into a conference bag)

Please contact [local_chairs @ tei.acm.org](mailto:local_chairs@tei.acm.org) if interested.